

# PS9121

HIGH CMR, 15 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5) 3.3 V PHOTOCOUPLER

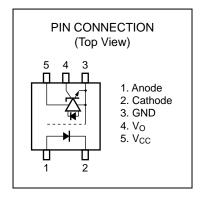
#### DESCRIPTION

The PS9121 is an optically coupled high-speed, active low type isolator containing an AlGaAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9121 is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion. The PS9121 is suitable for high density application.

## FEATURES

- Low power consumption ( $V_{CC} = 3.3 \text{ V}$ )
- Pulse width distortion ( $|t_{PHL} t_{PLH}| = 35 \text{ ns MAX.}$ )
- High common mode transient immunity (CM<sub>H</sub>, CM<sub>L</sub> =  $\pm 15 \text{ kV/}\mu \text{s MIN.}$ )
- Small package (SO-5)
- High-speed (15 Mbps)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Open collector output
- Ordering number of tape product: PS9121-F3 : 2 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL : UL1577, Single protection
  - CSA : CAN/CSA-C22.2 No.62368-1, Basic insulation
  - VDE : DIN EN 60747-5-5 (Option)



#### APPLICATIONS

- Measurement equipment
- PDP
- FA Network

#### TRUTH TABLE

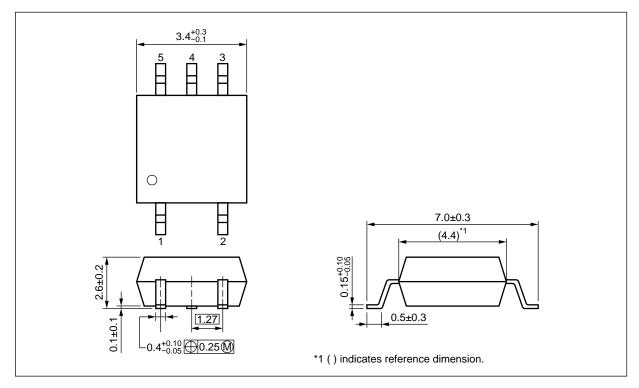
LED	Output
ON	L
OFF	Н

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R08DS0255EJ0100 Rev.1.00 Dec 1, 2021

## PACKAGE DIMENSIONS (UNIT: mm)

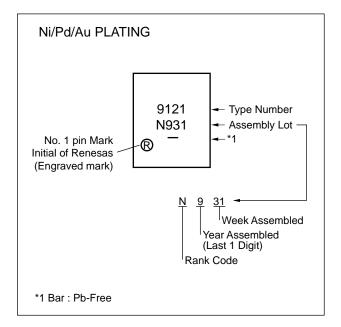


Weight: 0.08g (typ.)

## PHOTOCOUPLER CONSTRUCTION

Parameter MIN.	
Air Distance	4.2 mm
Creepage Distance	4.2 mm
Isolation Distance	0.2 mm

#### MARKING EXAMPLE





#### **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number <sup>*1</sup>
PS9121	PS9121-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9121
PS9121-F3	PS9121-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL, CSA approved)	
PS9121-V	PS9121-V-AX		20 pcs (Tape 20 pcs cut)	UL, CSA,	
PS9121-V-F3	PS9121-V-F3-AX		Embossed Tape 2 500 pcs/reel	DIN EN 60747-5-5 approved	

Notes\*: 1. For the application of the Safety Standard, following part number should be used.

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current *1	lF	30	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	7	V
	Output Voltage	Vo	7	V
	Output Current	lo	25	mA
	Power Dissipation *2	Pc	40	mW
Isolation V	oltage *3	BV	3 750	Vr.m.s.
Operating	Ambient Temperature	TA	- 40 to + 85	°C
Storage Te	emperature	Tstg	- 55 to + 125	°C

Notes\*:1. Reduced to 0.3 mA/°C at  $T_{\text{A}}$  = 25 °C or more.

- 2. Applies to output pin Vo (collector pin). Reduced to 1.5 mW/°C at  $T_A = 65$  °C or more.
- 3. AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-5 shorted together.

#### **RECOMMENDED OPERATING CONDITIONS**

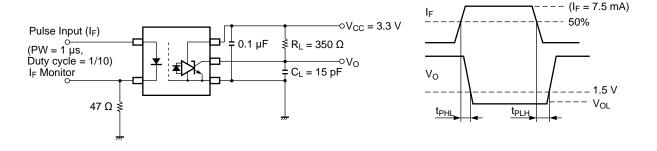
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	VFL	0		0.8	V
High Level Input Current	IFH	6.3	10	12.5	mA
Supply Voltage	Vcc	2.7	3.3	3.6	V
TTL (R <sub>L</sub> = 1 k $\Omega$ , loads)	Ν			5	
Pull-up Resistor	R∟	330		4 k	Ω

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = - 40 to +85 °C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25 °C	1.4	1.65	1.8	V
	Reverse Current	Ir	Vr = 3 V, Ta = 25 °C			10	μΑ
Terminal Capacitance		Ct	V = 0 V, f = 1 MHz, T <sub>A</sub> = 25 °C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 3.3 V, VF = 0.8 V		1	80	μA
			Vcc = Vo = 5.5 V, V <sub>F</sub> = 0.8 V		1*²		
	Low Level Output Voltage*3	Vol	$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 5 \text{ mA}, \text{ IoL} = 13 \text{ mA}$		0.2	0.6	V
			$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 5 \text{ mA}, \text{ I}_OL = 13 \text{ mA}$		0.2 <sup>*2</sup>		
	High Level Supply Current	Іссн	$V_{CC} = 3.3 \text{ V}, \text{ I}_F = 0 \text{ mA}, \text{ Vo} = \text{Open}$		4	7	mA
			$Vcc = 5.5 V$ , $I_F = 0 mA$ , $Vo = Open$		5*²		1
	Low Level Supply Current	lcc∟	Vcc = 3.3 V, IF = 10 mA, Vo = Open		7	10	
			Vcc = 5.5 V, IF = 10 mA, Vo = Open		9*²		
Coupled	Threshold Input Current	IFHL	$Vcc$ = 3.3 V, Vo = 0.8 V, RL = 350 $\Omega$		2.5	5	
	$(H \rightarrow L)$		Vcc = 5 V, Vo = 0.8 V, RL = 350 $\Omega$		2.5*²		
	Isolation Resistance	Ri-o	V⊦o = 1 kV <sub>DC</sub> , RH = 40 to 60 %, T <sub>A</sub> = 25 °C	10 <sup>11</sup>			Ω
	Isolation Capacitance	solation Capacitance $C_{I-O}$ $V = 0 V, f = 1 MHz, T_A = 25 °C$			0.6		pF
	Propagation Delay Time	<b>t</b> PHL	T <sub>A</sub> = 25 °C		40	75	ns
	$(H \rightarrow L)^{*4}$		Vcc = 3.3 V, R∟ = 350 Ω, I⊧ = 7.5 mA			100	
			$V_{CC}$ = 5 V, $R_L$ = 350 $\Omega$ , $I_F$ = 7.5 mA		37*2		
	Propagation Delay Time	<b>t</b> PLH	T <sub>A</sub> = 25 °C		45	75	
	$(L \rightarrow H)^{*4}$		$V_{CC} = 3.3 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$			100	
			$V_{CC} = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		40 <sup>*2</sup>		
	Rise Time	tr	$V_{CC}=3.3~V,~R_L=350~\Omega,~I_F=7.5~mA$		20		
			$V_{CC} = 5 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$		20 <sup>*2</sup>		
	Fall Time	tr	$V_{CC}=3.3~V,~R_{L}=350~\Omega,~I_{F}=7.5~mA$		5		
			$V_{CC} = 5 \text{ V},  \text{R}_{\text{L}} = 350  \Omega,  \text{I}_{\text{F}} = 7.5  \text{m}\text{A}$		5*²		
	Pulse Width Distortion	tphl-tplh	Vcc = 3.3 V, RL = 350 $\Omega$ , IF = 7.5 mA		5	35	
	(PWD)*4		$V_{CC} = 5 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$		3*2		
	Propagation Delay Skew	tрsк	$V_{CC} = 3.3 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$			40	
	Common Mode Transient Immunity at High	СМн		15	20		kV/μ
	Level Output <sup>*5</sup>		$    V_{CC} = 5 \ V, \ R_L = 350 \ \Omega, \ T_A = 25 \ ^{\circ}C, \\ I_F = 0 \ mA, \ V_O > 2 \ V, \ V_{CM} = 1 \ kV $		20*2		
	Common Mode Transient Immunity at Low	CM∟	$    V_{CC} = 3.3 \ V, \ R_L = 350 \ \Omega, \ T_A = 25 \ ^\circ C, \\ I_F = 7.5 \ mA, \ V_O < 0.8 \ V, \ V_{CM} = 1 \ kV $	15	20		
	Level Output*5		$    V_{CC} = 5 \ V, \ R_L = 350 \ \Omega, \ T_A = 25 \ ^\circ C, \\ I_F = 7.5 \ mA, \ V_O < 0.8 \ V, \ V_{CM} = 1 \ kV $		20*²		

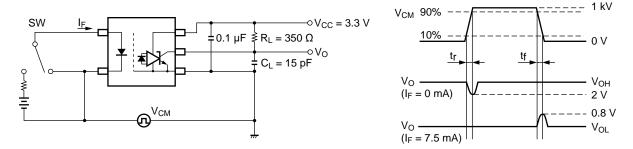
Notes\*:1. Typical values at  $T_A = 25 \text{ °C}$ .

- 2. These values are reference values
- 3. Because  $V_{OL}$  of 2 V or more may be output when LED current input and when output supply of  $V_{CC} = 2.6$  V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- 4. Test circuit for propagation delay time



Remark: CL includes probe and stray wiring capacitance.

5. Test circuit for common mode transient immunity



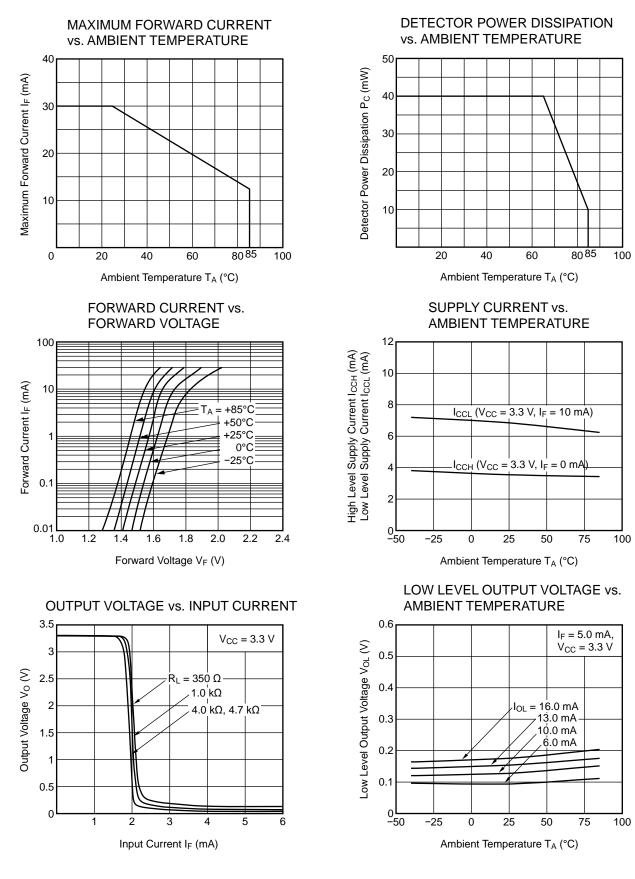
Remark: C<sub>L</sub> includes probe and stray wiring capacitance.

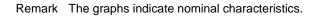
#### **USAGE CAUTIONS**

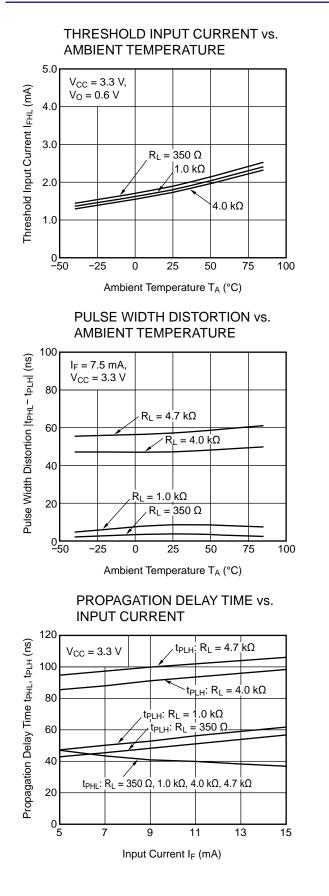
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1  $\mu$ F is used between V<sub>CC</sub> and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.
- 4. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 5. Do not use fixing agents or coatings containing halogen-based substances.



## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C unless otherwise specified)

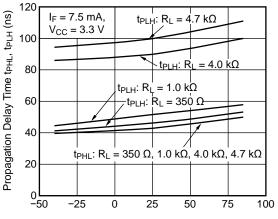






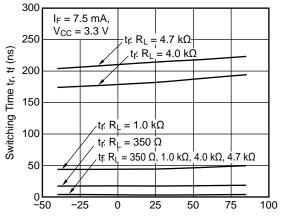
Remark The graphs indicate nominal characteristics.

#### PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



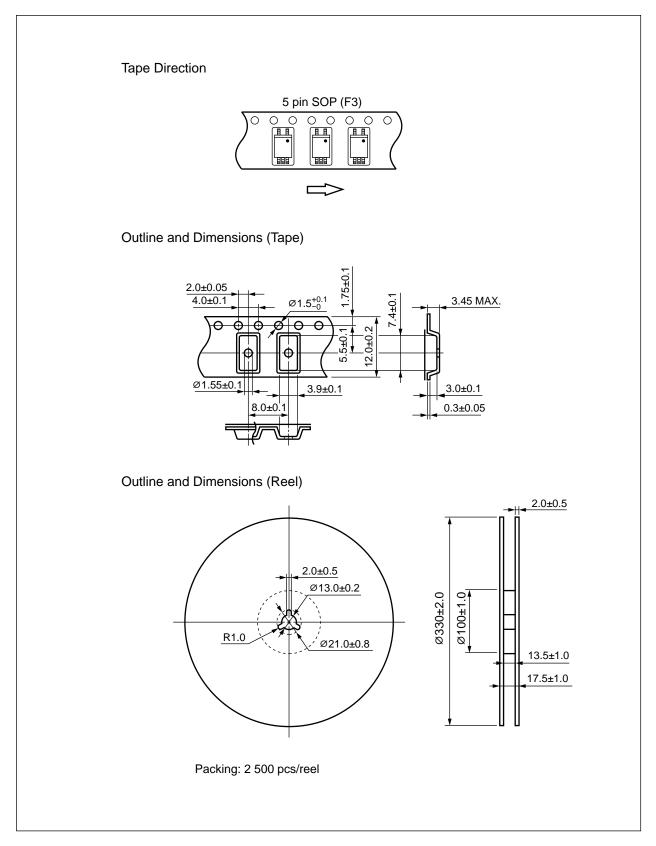
Ambient Temperature T<sub>A</sub> (°C)

SWITCHING TIME vs. AMBIENT TEMPERATURE

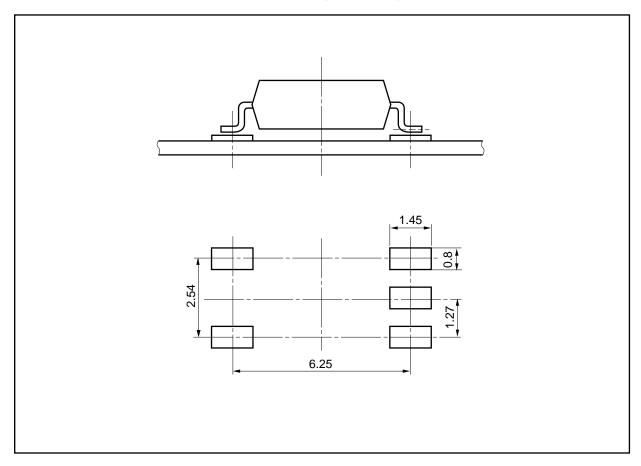


Ambient Temperature T<sub>A</sub> (°C)

## **TAPING SPECIFICATIONS (UNIT: mm)**



## **RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**



Remark All dimensions in this figure must be evaluated before use.



## NOTES ON HANDLING

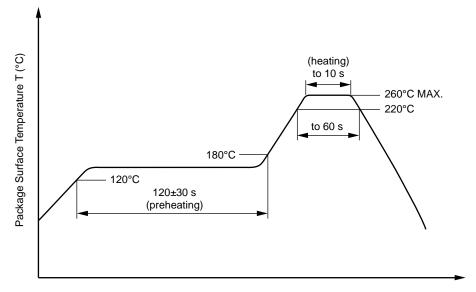
- 1. Recommended soldering conditions
  - (1) Infrared reflow soldering
    - Peak reflow temperature
    - Time of peak reflow temperature
    - Time of temperature higher than 220 °C
    - $\bullet$  Time to preheat temperature from 120 to 180 °C  $\,$  120  $\pm$  30 s  $\,$
    - Number of reflows
    - Flux

10 seconds or less 60 seconds or less 120  $\pm$  30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

260 °C or below (package surface temperature)

0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

- (2) Wave soldering
  - Temperature 260 °C or below (molten solder temperature)
  - Time 10 seconds or less
  - Preheating conditions 120 °C or below (package surface temperature)
  - Number of times One (Allowed to be dipped in solder including plastic mold portion.)
  - Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350 °C or below
- Time (each pins) 3 seconds or less
- Flux

Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100  $^\circ\text{C}$
- (4) Cautions
  - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

## 2. Cautions regarding noise

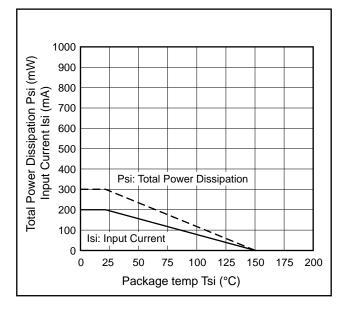
Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.



## SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

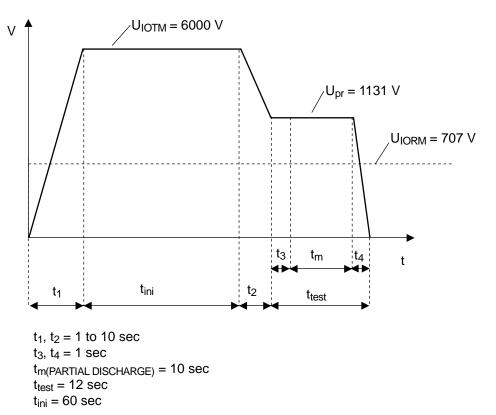
Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/85/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	707	V <sub>peak</sub>
Test voltage (partial discharge test, procedure a for type test and random test)	Upr	1 131	V <sub>peak</sub>
$U_{pr}$ = 1.6 × $U_{IORM.}$ , $P_d$ < 5 pC			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1 326	V <sub>peak</sub>
$U_{pr}$ = 1.875 × U <sub>IORM.</sub> , $P_d$ < 5 pC			
Highest permissible overvoltage	UIOTM	6 000	V <sub>peak</sub>
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T <sub>stg</sub>	- 55 to +125	°C
Operating temperature range	TA	- 40 to +85	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at } T_A = 25 \text{ °C}$	Ris MIN.	10 <sup>12</sup>	Ω
$V_{IO}$ = 500 V dc at T <sub>A</sub> MAX. at least 100 °C	Ris MIN.	10 <sup>11</sup>	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	150	°C
Current (input current I <sub>F</sub> , Psi = 0)		200	mA
Power (output or total power dissipation)	Psi	300	mW
Isolation resistance			
$V_{IO} = 500 \text{ V dc at } T_A = Tsi$	Ris MIN.	10 <sup>9</sup>	Ω

## Dependence of maximum safety ratings with package temperature

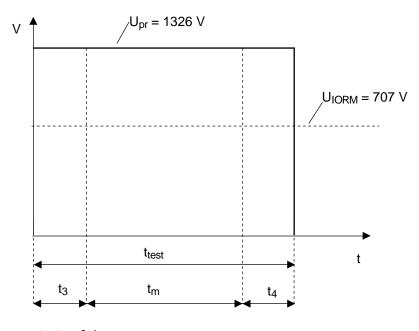








#### Method b) Non-destructive Test, 100% Production Test



 $t_{3}, t_{4} = 0.1 \text{ sec} \\ t_{m}(\text{PARTIAL DISCHARGE}) = 1.0 \text{ sec} \\ t_{test} = 1.2 \text{ sec}$ 

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or i any way allow it to enter the mouth.

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